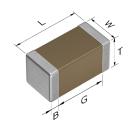
## 积层贴片陶瓷片式电容器

## C1608X5R0J685K080AB

RoHS Reach Halogen Free Pb Free

交货型号	C1608X5R0J685KT****
用途	一般等级
特点	General 一般(~75V)
系列	C1608 [EIA 0603]
状态	▲ 量产体制(新设计非推荐)



	尺寸
长度(L)	1.60mm ±0.10mm
宽度(W)	0.80mm ±0.10mm
厚度(T)	0.80mm ±0.10mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.30mm Min.
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)
1世代外型141/四(11.6)	0.60mm to 0.80mm(Reflow Soldering)
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)
1世存/杆益41/四 (FD)	0.60mm to 0.80mm(Reflow Soldering)
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)
3世代丹並仰四日日	0.60mm to 0.80mm(Reflow Soldering)

······································	气特性
电容	6.8 μF ±10%
额定电压	6. 3VDC
温度特性	$X5R(\pm 15\%)$
耗散因数 (Max.)	10%
绝缘电阻 (Min.)	14ΜΩ

	其他	
焊接方法	流体	
件按月伝	回流	
AEC-Q200	NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.



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特性图表(这是参考数据,并不保证产品的特性。)

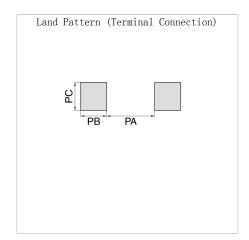
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## Associated Images



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